



Silicon Application Corp.

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## **Modular Approval Letter**

Date: 2016-06-08

To whom it may concern:

We, Silicon Application Corp., hereby request Modular Approval for Product:  
LINKIT7687HDK

(Model number: LINKIT7687HDK, FCC ID: 2AINMLINKIT7687HDK).

The EUT meets the requirement for modular approval as detailed in FCC Public  
Notice DA 00-1407. Compliance to each of the requirements is described below:

1. The modular transmitter have its own RF shielding. Please refer the product photo.
2. The modular transmitter has buffered modulation/data inputs, Buffered data inputs stage has been integrated in chip (Model: MT7687FN).
3. The modular transmitter has its own power supply regulation. Please refer to the Block Diagram.
4. Comply with the antenna requirements of Section 15.203 and 15.204(c), the module has 1 FPC Antenna with 1dBi antenna gain.
5. The modular transmitter be tested in a stand-alone configuration =>please refer to the setup photos.
6. The modular transmitter have a label on the modular's shielding, labeled with its own FCC ID number: 2AINMLINKIT7687HDK
7. Comply with any specific rules or operating requirements that ordinarily apply to a complete transmitter and the manufacturer must provide adequate instructions along with the module to explain any such requirements. The necessary explanation to be complied with this requirement is contained in the user manual, and please refers to the User Manual.
8. Comply with any applicable RF exposure requirements in its final configuration.

Sincerely Yours,

Signature:

YL Qiao

Product Manager